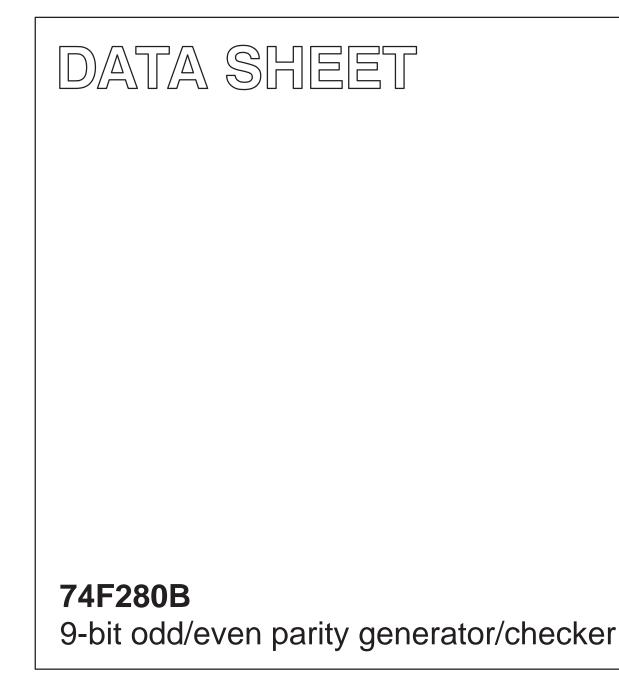
INTEGRATED CIRCUITS



Product specification

1996 Mar 12

IC15 Data Handbook



HILIPS

9-bit odd/even parity generator/checker

74F280B

FEATURES

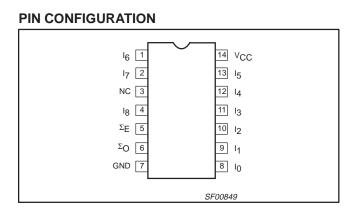
- High-impedance NPN base inputs for reduced loading (20µA in Low and High states)
- Buffered inputs one normalized load
- Word length easily expanded by cascading
- Industrial temperature range available (-40°C to +85°C)

DESCRIPTION

The 74F280B is a 9-bit Parity Generator or Checker commonly used to detect errors in high speed data transmission or data retrieval systems. Both Even (Σ_E) and Odd (Σ_O) parity outputs are available for generating or checking even or odd parity on up to 9 bits.

The Even (Σ_E) parity output is High when an even number of Data inputs $(I_0 - I_8)$ are High. The Odd (Σ_0) parity output is High when an odd number of Data inputs are High.

Expansion to larger word sizes is accomplished by tying the Even (Σ_{E}) outputs of up to nine parallel devices to the data inputs of the final stage. This expansion scheme allows an 81-bit data word to be checked in less than 20ns.



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F280B	5.5ns	26mA

ORDERING INFORMATION

DESCRIPTION	COMMERCIAL RANGE V _{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	INDUSTRIAL RANGE V_{CC} = 5V ±10%, T_{amb} = -40°C to +85°C	PKG. DWG. #
14-pin plastic DIP	N74F280BN	I74F280BN	SOT27-1
14-pin plastic SO	N74F280BD	I74F280BD	SOT108-1

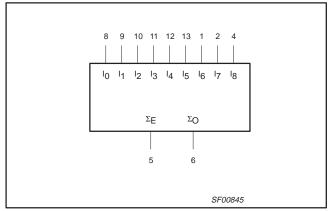
INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
l ₀ - l ₈	Data inputs	1.0/0.033	20μΑ/20μΑ
Σε, Σο	Parity outputs	50/33	1.0mA/20mA

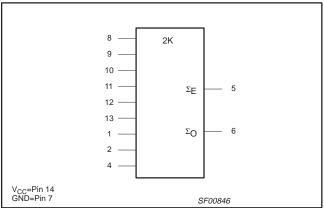
NOTE:

One (1.0) FAST Unit Load is defined as: 20µA in the High state and 0.6mA in the Low state.

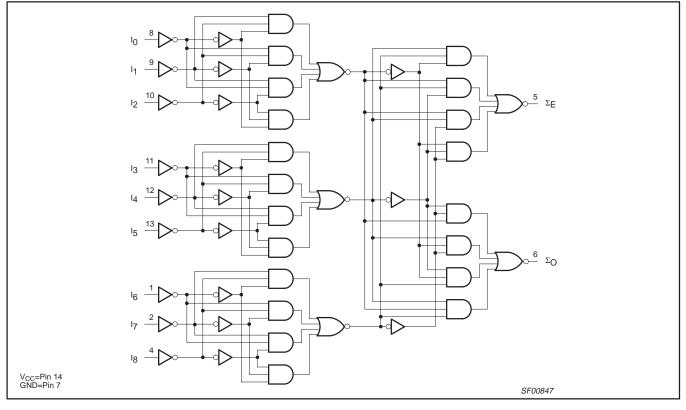
LOGIC SYMBOL



IEC/IEEE SYMBOL



LOGIC DIAGRAM



FUNCTION TABLE

INPUTS	OUTPUTS			
Number of High Data Inputs $(I_0 - I_8)$	Σ_{E}	Σο		
Even — 0, 2, 4, 6, 8	Н	L		
Odd — 1, 3, 5, 7, 9	L	Н		

H = High voltage level L = Low voltage level

9-bit odd/even parity generator/checker

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETI	ER	RATING	UNIT
V _{CC}	Supply voltage		-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V	
I _{IN}	Input current	-30 to +5	mA	
V _{OUT}	Voltage applied to output in High output state	-0.5 to V _{CC}	V	
I _{OUT}	Current applied to output in Low output state		40	mA
Ŧ		Commercial range	0 to +70	°C
T _{amb}	Operating free-air temperature range	Industrial range	-40 to +85	°C
T _{stg}	Storage temperature	-	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

CYMDOL			LIMITS				
SYMBOL	PARAMETE	Min	Nom	Max	UNIT		
V _{CC}	Supply voltage	Supply voltage				V	
V _{IH}	High-level input voltage	2.0			V		
VIL	Low-level input voltage			0.8	V		
I _{IK}	Input clamp current				-18	mA	
I _{OH}	High-level output current				-1	mA	
I _{OL}	Low-level output current				20	mA	
-	Operating free air temperature reaso	Commercial range	0		70	°C	
amb	Operating free-air temperature range	Industrial range	-40		85	°C	

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	DADAME	TED	TEST CONDITIO			UNIT		
STMBOL		PARAMETER		TEST CONDITIONS.			MAX	UNIT
V			$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}	2.5			V
V _{OH}	OH High-level output voltage		$V_{IH} = MIN, I_{OH} = MAX$	±5%V _{CC}	2.7	3.4		v
V			$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}		0.35	0.50	V
V _{OL}	CoL Low-level output voltage		$V_{IH} = MIN, I_{OL} = MAX$	±5%V _{CC}		0.35	0.50	v
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V
lı	Input current at maximum	n input voltage	$V_{CC} = 0.0V, V_{I} = 7.0V$				100	μΑ
		Commercial range					20	μΑ
łн	High-level input current	Industrial range	$v_{\rm CC} = 101AX, v_1 = 2.7v$	$V_{CC} = MAX, V_I = 2.7V$			40	μA
IIL	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-20	μA
I _{OS}	Short-circuit output current ³		V _{CC} = MAX		-60		-150	mA
I _{CC}	Supply current (total)	Supply current (total)				26	35	mA

NOTES:

 For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting the base of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting the base of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting the base of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting the base of high-speed test apparatus and/or sample-and-hold techniques. of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, IOS tests should be performed last.

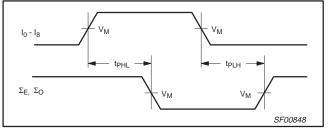
9-bit odd/even parity generator/checker

AC ELECTRICAL CHARACTERISTICS

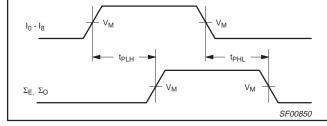
	PARAMETER				LIMITS						
SYMBOL			PARAMETER TEST V CONDITIONS C			$\begin{array}{c c} T_{amb} = +25^\circ C & T_{amb} = 0^\circ C \ to \ +70 \\ V_{CC} = +5.V & V_{CC} = +5.V \pm 10^\circ \\ C_L = 50pF, & C_L = 50pF, \\ R_L = 500\Omega & R_L = 500\Omega \end{array}$.V ± 10% 50pF,	$ \begin{array}{c} T_{amb} = -40^{\circ} C \ to \ +85^{\circ} C \\ V_{CC} = +5.V \pm 10\% \\ C_L = 50 p F, \\ R_L = 500 \Omega \end{array} $		UNIT
				Min	Тур	Max	Min	Max	Min	Max	
t _{PLH} t _{PHL}	Propagation delay $I_0 - I_8$ to Σ_E	74F280B	Waveform 1, 2	4.0 4.0	6.5 7.0	9.0 10.0	3.5 3.5	10.0 11.1	3.0 3.5	11.0 12.0	ns ns
t _{PLH} t _{PHL}	Propagation delay $I_0 - I_8$ to Σ_0	74F200D	Waveform 1, 2	4.0 4.0	6.5 7.0	9.0 10.0	3.5 3.5	10.0 11.0	3.0 3.5	11.0 12.0	ns ns

AC WAVEFORMS

For all waveforms, V_M=1.5V.



Waveform 1. **Propagation Delay for Inverting Outputs**



Waveform 2. **Propagation Delay for Non-Inverting Outputs**

INPUT PULSE REQUIREMENTS

rep. rate

1MHz

tw

500ns

t_{TLH}

2.5ns

t_{THL}

2.5ns

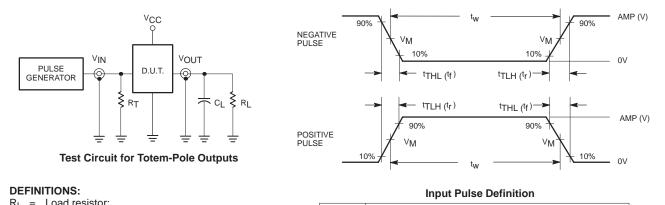
Vм

1.5V

amplitude

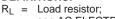
3.0V

TEST CIRCUIT AND WAVEFORM



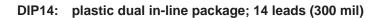
family

74F

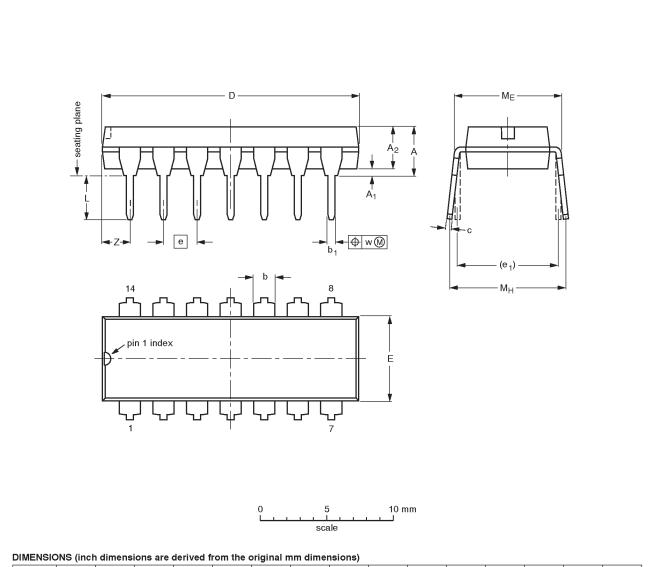


- see AC ELECTRICAL CHARACTERISTICS for value. Load capacitance includes jig and probe capacitance; CL = see AC ELECTRICAL CHARACTERISTICS for value.
- $R_T =$ Termination resistance should be equal to Z_{OUT} of pulse generators.

SE	-00	006	



Philips Semiconductors



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

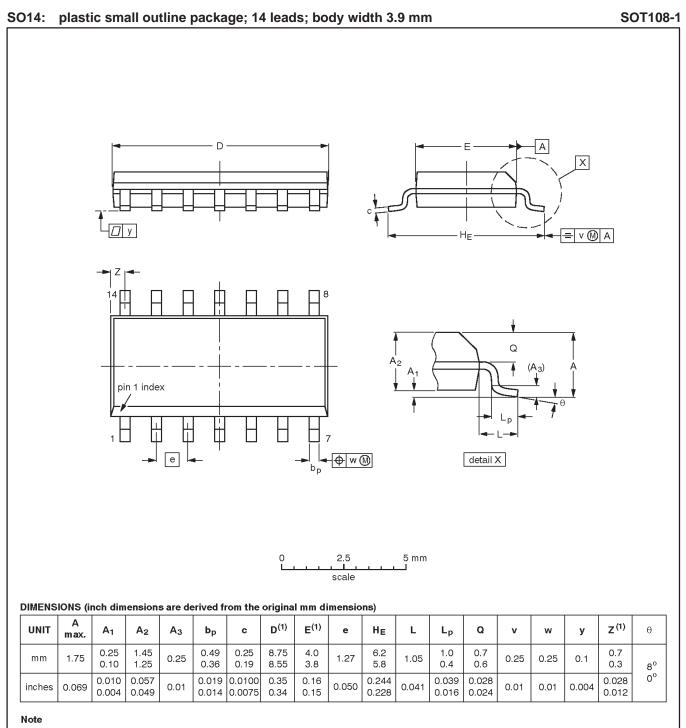
OUTLINE		REFER	ENCES	EUROPEAN		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT27-1	050G04	MO-001AA			-92-11-17 95-03-11	

74F280B

Product specification

1996 Mar 12

9-bit parity odd/even parity generator/checker



1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT108-1	076E06S	MS-012AB			-95-01-23 97-05-22	

9-bit parity odd/even parity generator/checker

74F280B

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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